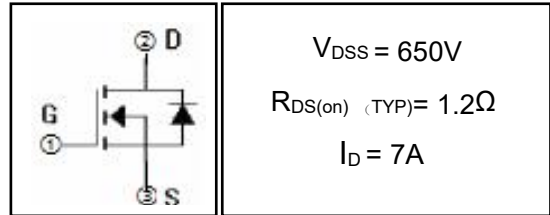


7A 650V N-channel Enhancement Mode Power MOSFET

1 Description

These N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. Which accords with the RoHS standard.

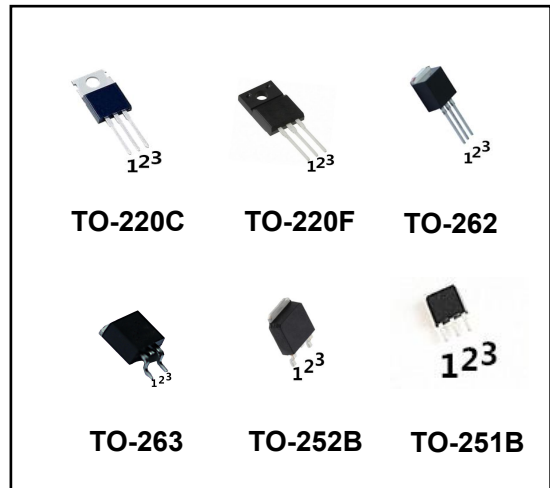


2 Features

- Fast Switching
- ESD Improved Capability
- Low ON Resistance($R_{DS(on)} \leq 1.4\Omega$)
- Low Gate Charge(Typical Data:24nC)
- Low Reverse Transfer Capacitances(Typical:5.5pF)
- 100% Single Pulse Avalanche Energy Test
- 100% ΔV_{DS} Test

3 Applications

- used in various power switching circuit for system miniaturization and higher efficiency.
- Power switch circuit of electron ballast and adaptor.



4 Electrical Characteristics

4.1 Absolute Maximum Rating ($T_c=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Value		Units	
		7N65/I7N65/E7N65 /B7N65/D7N65	F7N65		
Maximum Drain-Source DC Voltage	V_{DS}	650		V	
Maximum Gate-Drain Voltage	V_{GS}	± 30		V	
Drain Current(continuous)	I_D ($T=25^\circ\text{C}$) ($T=100^\circ\text{C}$)	7		A	
		4.4		A	
Drain Current(Pulsed) ^(Note 1)	I_{DM}	28		A	
Single Pulse Avalanche Energy ^(Note 5)	E_{AS}	350		mJ	
Peak Diode Recovery dv/dt ^(Note 6)	dv/dt	5		V/ns	
Total Dissipation	$T_a=25^\circ\text{C}$	P_{tot}	2	2	W
	$T_c=25^\circ\text{C}$	P_{tot}	100	35	W
Junction Temperature	T_j	150		$^\circ\text{C}$	
storage Temperature	T_{stg}	-55~150		$^\circ\text{C}$	
Maximum Temperature for soldering	T_L	300		$^\circ\text{C}$	

4.2 Thermal Characteristics

Parameter	Symbol	Value		Unit
		7N65/I7N65/E7N65 /B7N65/D7N65	F7N65	
Thermal Resistance Junction to Case-sink	R_{thJC}	1.25	3.57	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient	R_{thJA}	62.5	62.5	$^\circ\text{C/W}$

4.3 Electrical Characteristics (Tc=25°C, unless otherwise noted)

Parameter	Symbol	Test Condition	Value			Units
			Min	Typ	Max	
Off Characteristics						
Drain-source Breakdown Voltage	BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	650	--	--	V
Drain-to-Source Leakage Current	I_{DSS}	$V_{DS}=650V, V_{GS}=0V, T_C=25^\circ C$	--	--	1	μA
		$V_{DS}=520V, V_{GS}=0V, T_C=125^\circ C$	--	--	100	μA
Gate-to-Source Forward Leakage	I_{GSSF}	$V_{GS}=+30V$	--	--	100	nA
Gate-to-Source Reverse Leakage	I_{GSSR}	$V_{GS}=-30V$	--	--	-100	nA
On Characteristics (Note 3)						
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	--	4	V
Drain-source on Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=3.5A$	--	1.2	1.4	Ω
Dynamic Characteristics (Note 4)						
Forward Transfer conductance	g_{fs}	$V_{DS}=15V, I_D=3.5A$	--	6.5	--	S
Input Capacitance	C_{iss}	$V_{GS}=0V, V_{DS}=25V, f=1.0MHz$	--	1130	--	pF
Output Capacitance	C_{oss}		--	93	--	
Reverse Transfer Capacitance	C_{rss}		--	5.5	--	
Switching Characteristics (note4)						
Turn-on Delay Time	$t_{d(on)}$	$I_D=7A, V_{DD}=325V, R_G=10\Omega$	--	19	--	nS
Turn-on Rise Time	t_r		--	21	--	nS
Turn-off Delay Time	$t_{d(off)}$		--	42	--	nS
Turn-off Fall Time	t_f		--	19	--	nS
Total Gate Charge	Q_g	$I_D=7A, V_{DD}=520V, V_{GS}=10V$	--	24	--	nC
Gate-to-Source Charge	Q_{gs}		--	5.1	--	
Gate-to-Drain("Miller") Charge	Q_{gd}		--	9.5	--	
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{FSD}	$V_{GS}=0V, I_S=7A$	--	--	1.5	V
Diode Forward Current (Note 2)	I_S		--	--	7	A
Reverse Recovery Time	t_{rr}	$T_J=25^\circ C, I_F=7A, di/dt=100A/\mu S, V_{GS}=0V$	--	382	--	nS
Reverse Recovery Charge	Q_{rr}		--	1980	--	nC
Reverse Recovery Current	I_{RRM}		--	10.4	--	A

Notes:

- 1: Repetitive rating, pulse width limited by maximum junction temperature.
- 2: Surface mounted on FR4 Board, $t_s \leq 10sec$.
- 3: Pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
- 4: Guaranteed by design, not subject to production.
5. $L=10mH, I_D=8.4A, V_{DD}=50V, V_{GATE}=650V, Start T_J=25^\circ C$.
6. $I_{SD}=7A, di/dt \leq 100A/\mu s, V_{DD} \leq BV_{DSS}, Start T_J=25^\circ C$.

5 Typical characteristics diagrams

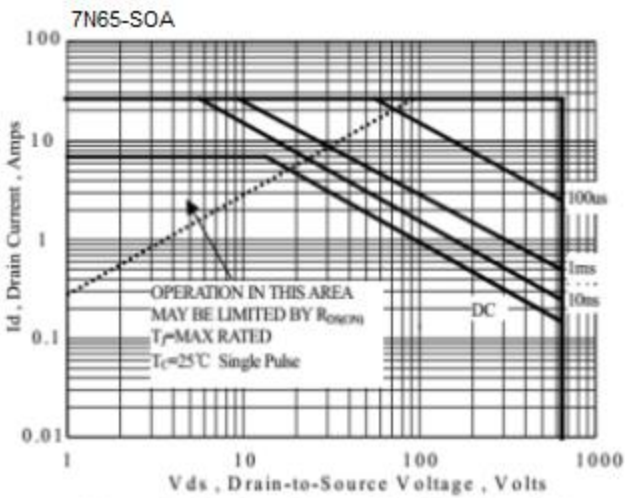


Figure 1 Maximum Forward Bias Safe Operating Area

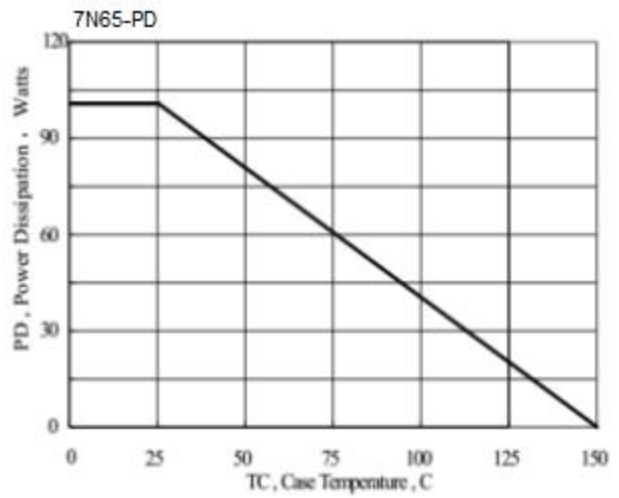


Figure 2 Maximum Power Dissipation vs Case Temperature

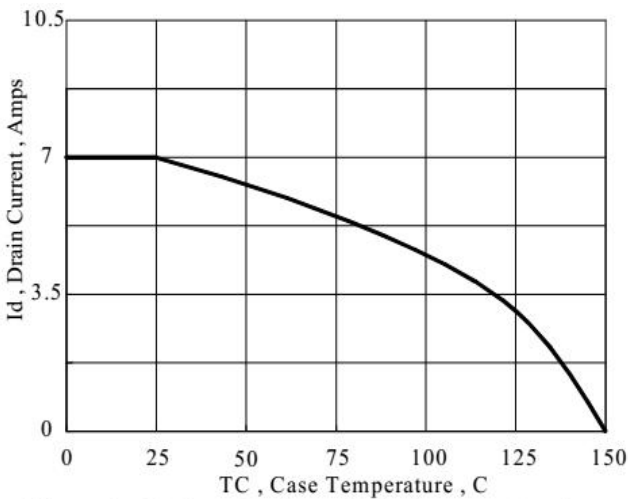


Figure 3 Maximum Continuous Drain Current vs Case Temperature

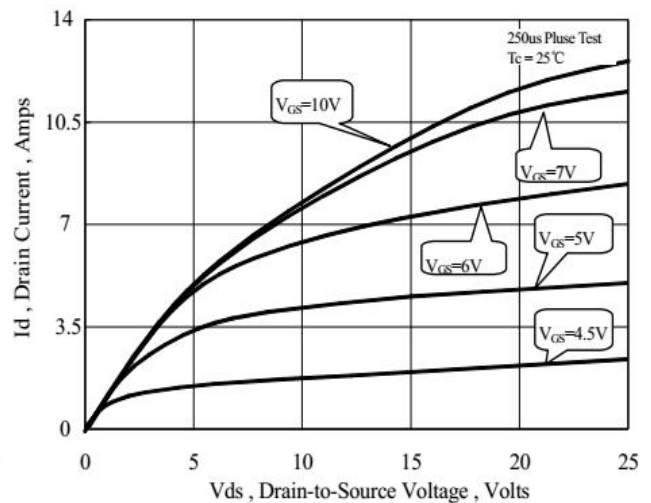


Figure 4 Typical Output Characteristics

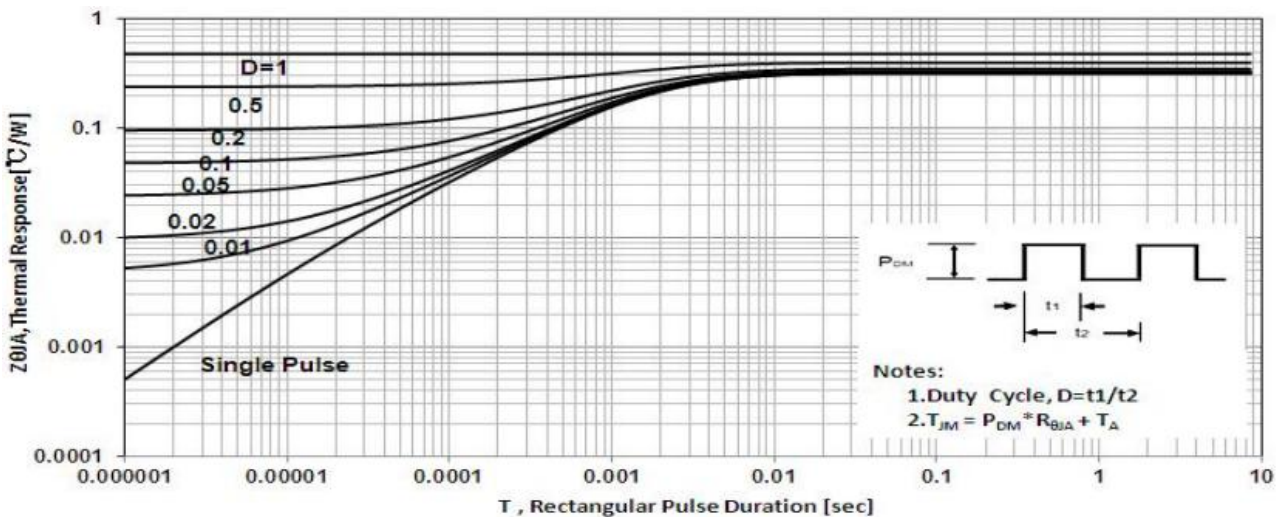


Figure 5 Maximum Effective Thermal Impedance, Junction to Case

5 Typical characteristics diagrams(continues)

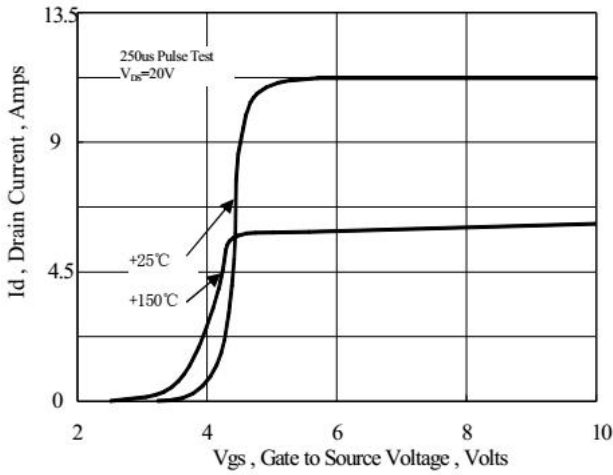


Figure 6 Typical Transfer Characteristics

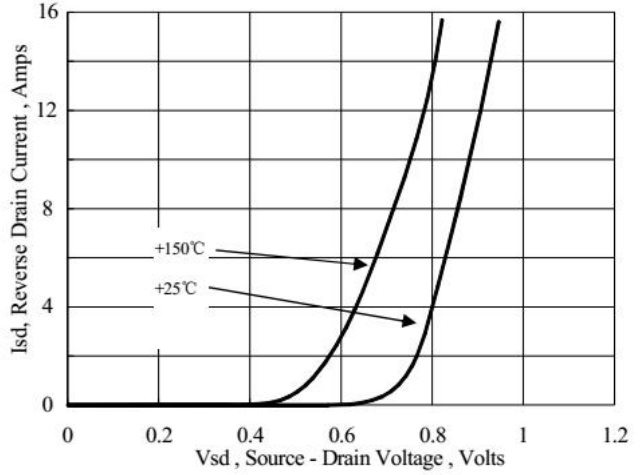


Figure 7 Typical Body Diode Transfer Characteristics

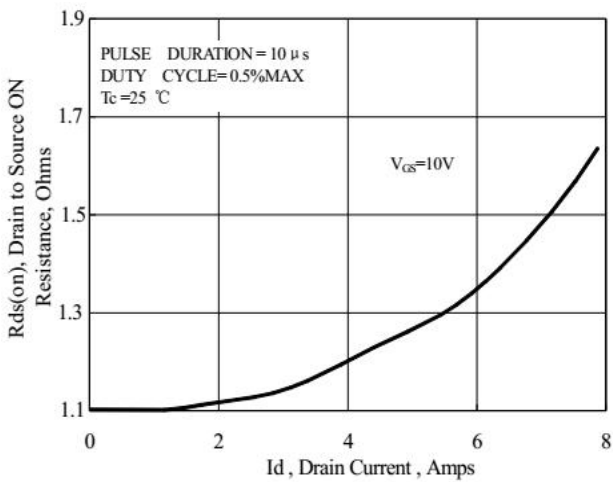


Figure 8 Typical Drain to Source ON Resistance vs Drain Current

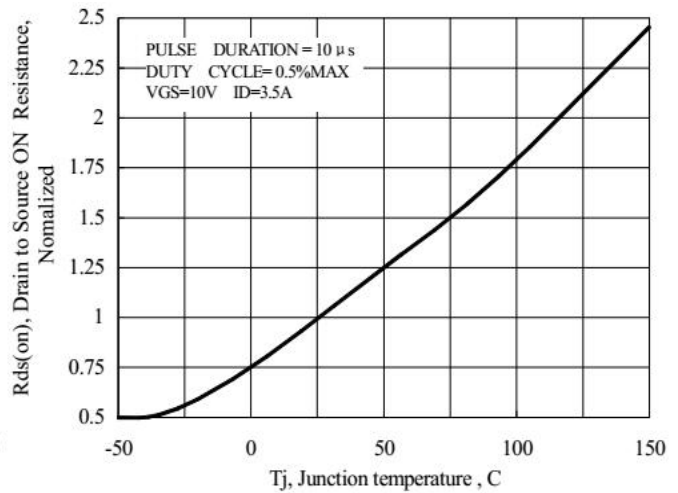


Figure 9 Typical Drain to Source on Resistance vs Junction Temperature

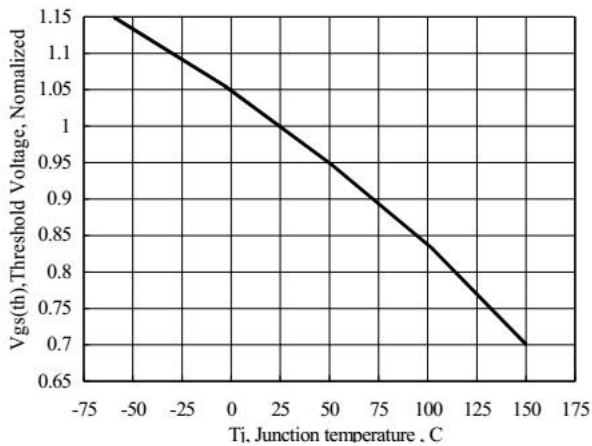


Figure 10 Typical Threshold Voltage vs Junction Temperature

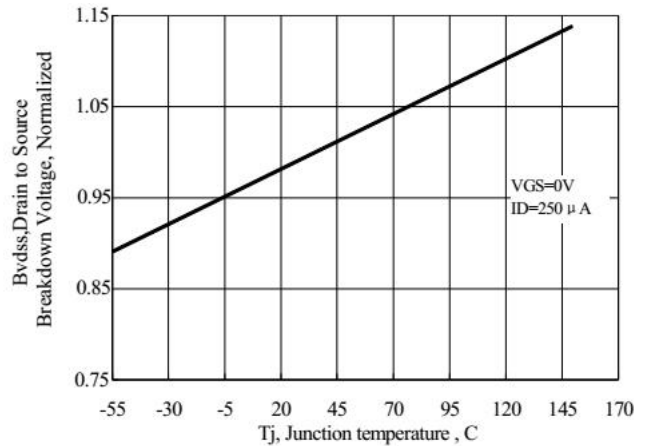


Figure 11 Typical Breakdown Voltage vs Junction Temperature

5 Typical characteristics diagrams(continues)

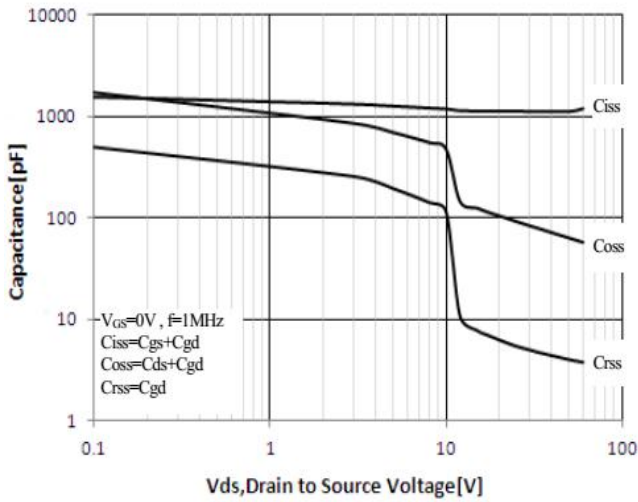


Figure 12 Typical Capacitance vs Drain to Source Voltage

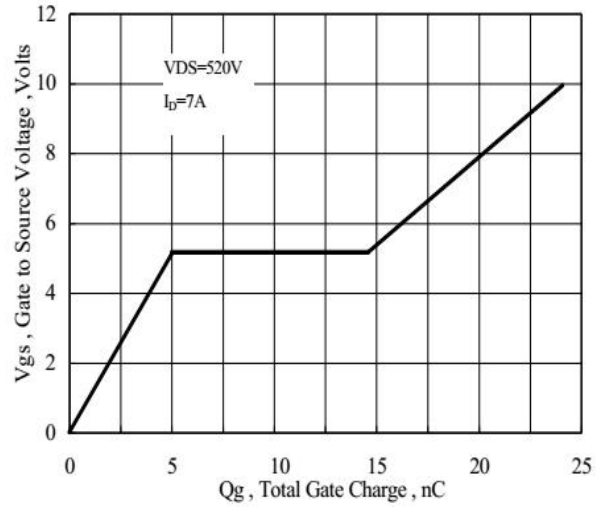


Figure 13 Typical Gate Charge vs Gate to Source Voltage

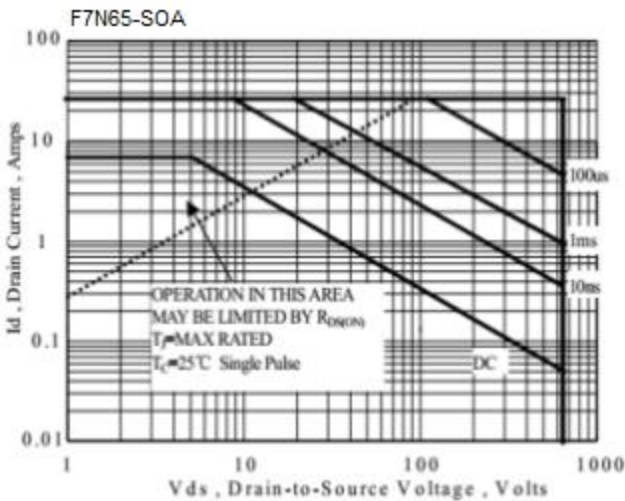


Figure 14 Maximum Forward Bias Safe Operating Area

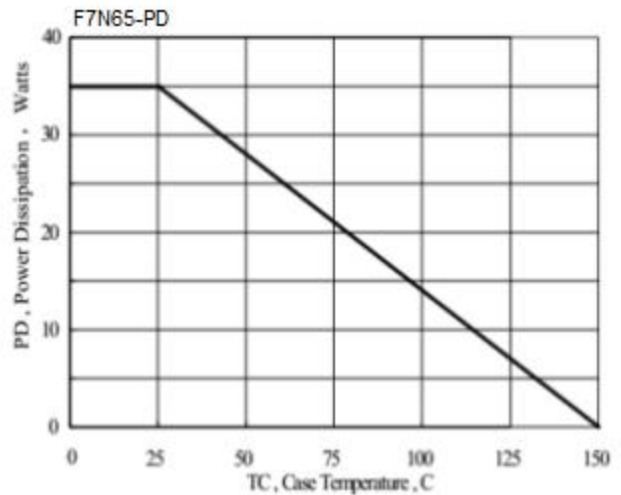


Figure 15 Maximum Power Dissipation vs Case Temperature

6 Typical Test Circuit and Waveform

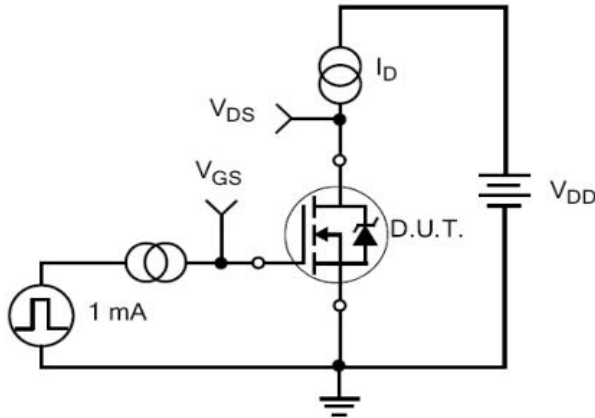


Figure 17. Gate Charge Test Circuit

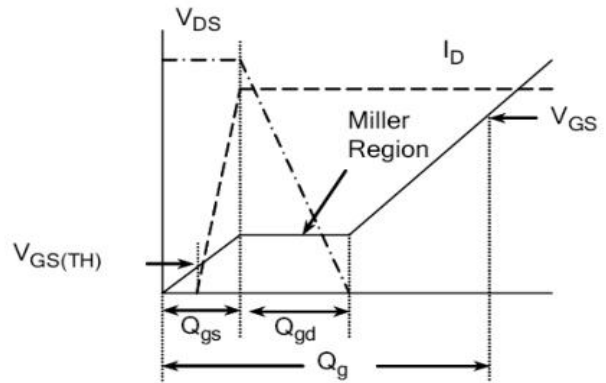


Figure 18. Gate Charge Waveform

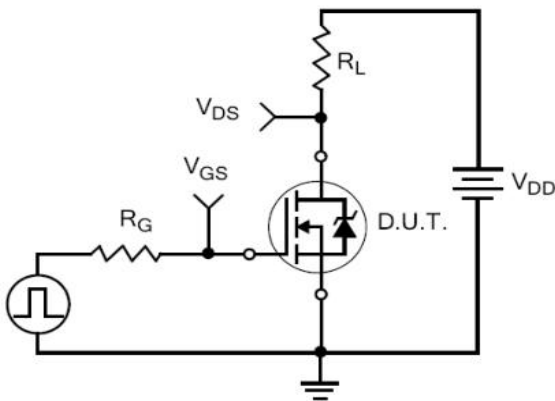


Figure 19. Resistive Switching Test Circuit

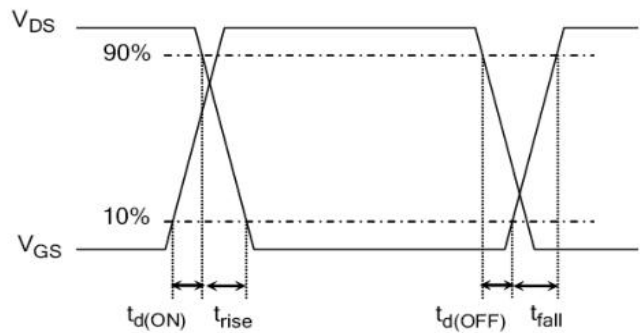


Figure 20. Resistive Switching Waveforms

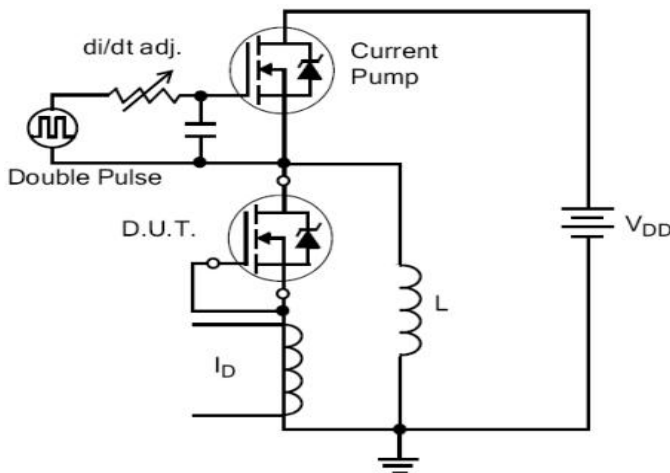


Figure 21. Diode Reverse Recovery Test Circuit

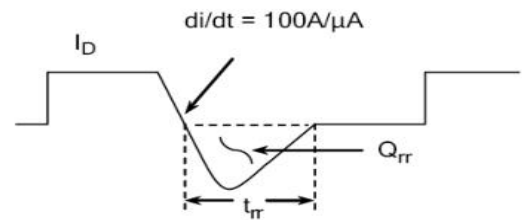


Figure 22. Diode Reverse Recovery Waveform

6 Typical Test Circuit and Waveform(continues)

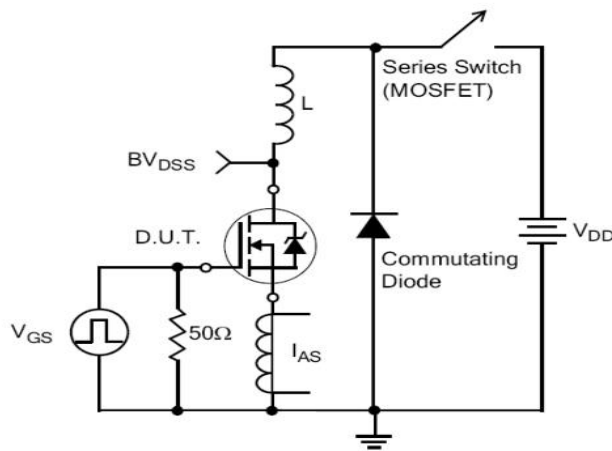


Figure 23. Unclamped Inductive Switching Test Circuit

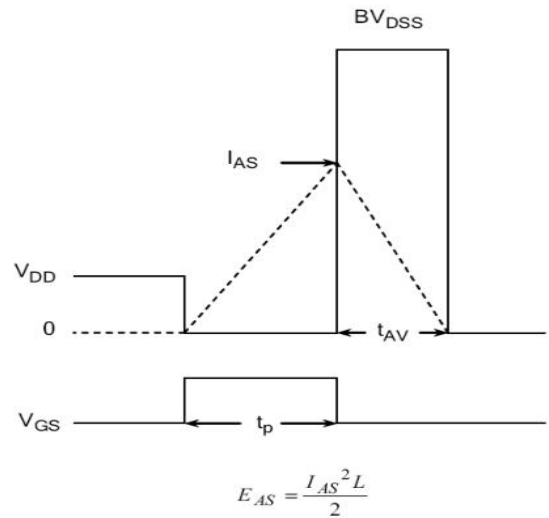


Figure 24. Unclamped Inductive Switching Waveforms

7 Product Names Rules

F X X N E X X

Packaging Code
220F: F 220: Nothing
251: B 252: D
262: I 263: E

Rated Voltage Code
With 2 Digital, For Example:
60 on behalf of 600V,
06 on behalf of 60v

Rated Current Code
With 1-2 Digital,
For Example:
4 on behalf of 4A,
10 on behalf of 10A,
08 on behalf of 0.8A

Special Function Code
E on behalf of build-in ESD
Nothing on behalf of not ESD

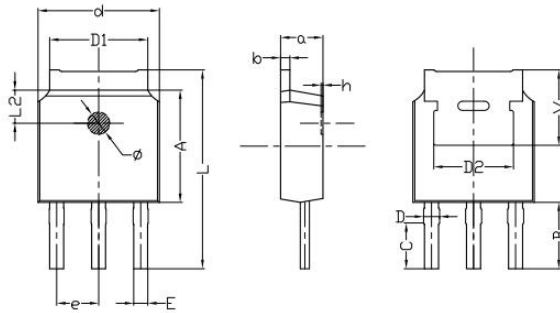
Channel Polarity Code
N on behalf of N channel
P on behalf of P channel

8 Product Specifications and Packaging Models

Product Model	Package Type	Mark Name	RoHS	Package	Quantity
7N65	TO-220C	7N65	Pb-free	Tube	1000/box
F7N65	TO-220F	F7N65	Pb-free	Tube	1000/box
B7N65	TO-251	B7N65	Pb-free	Tube	1000/box
D7N65	TO-252	D7N65	Pb-free	Tape & Reel	3000/box
I7N65	TO-262	I7N65	Pb-free	Tube	1000/box
E7N65	TO-263	E7N65	Pb-free	Tape & Reel	800/box

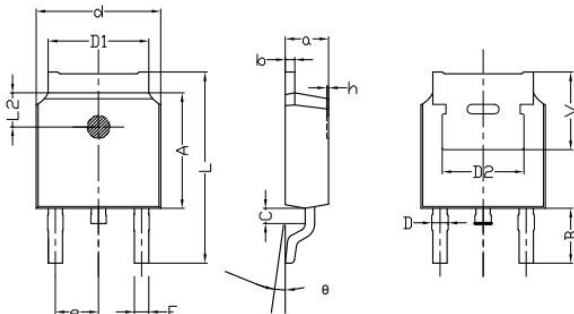
9 Dimensions

TO-251B PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	min.	max.	min.	max.
a	2.20	2.40	0.087	0.0946
b	0.46	0.58	0.018	0.023
C	2.45	2.65	0.097	0.104
D	0.80	0.90	0.032	0.035
d	6.30	6.70	0.248	0.264
D1	5.00	5.50	0.197	0.217
D2	TYP 4.83		TYP 0.190	
A	5.80	6.20	0.228	0.244
e	2.19	2.39	0.086	0.094
L	10.40	11.00	0.4098	0.4334
B	3.50	3.70	0.1379	0.1458
L2	1.5	1.8	0.059	0.071
φ	1.10	1.30	0.0433	0.0512
h	0.00	0.30	0.000	0.012
V	5.25	5.85	0.207	0.230
E	0.60	0.80	0.0236	0.0315

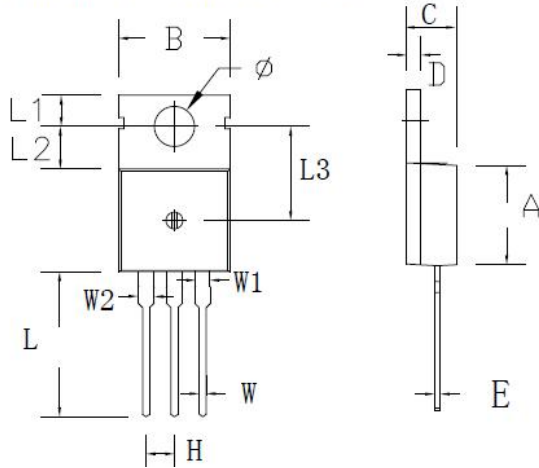
TO-252B PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	min.	max.	min.	max.
a	2.20	2.40	0.087	0.095
b	0.46	0.58	0.018	0.023
c	0.70	0.90	0.028	0.035
D	0.80	1.00	0.032	0.039
d	6.30	6.70	0.248	0.264
D1	5.00	5.50	0.197	0.217
D2	TYP 4.83		TYP 0.190	
A	5.80	6.20	0.228	0.244
e	2.19	2.39	0.086	0.094
L	9.40	10.40	0.370	0.409
B	2.6	3.2	0.102	0.126
L2	1.5	1.8	0.059	0.071
θ	0	8	0	8
h	0	0.3	0	0.012
V	5.25	5.85	0.207	0.230

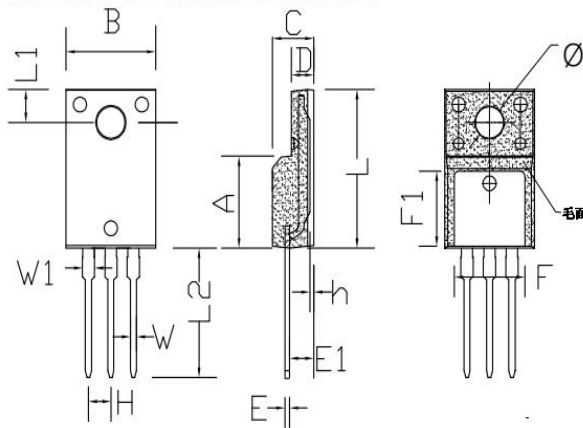
9 Dimensions(continues)

TO-220C PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	min.	max.	min.	max.
A	8.80	9.30	0.346	0.366
B	9.70	10.30	0.382	0.406
C	4.25	4.75	0.167	0.187
D	1.20	1.45	0.047	0.057
E	0.40	0.60	0.016	0.024
H	2.54 TYP		0.100 TYP	
W	0.60	0.95	0.024	0.037
W1	1.05	1.45	0.041	0.057
W2	1.20	1.60	0.047	0.063
L	12.60	13.40	0.496	0.528
L1	2.45	2.95	0.096	0.116
L2	3.45	3.95	0.136	0.156
L3	8.15	8.65	0.321	0.341
phi	3.50	3.90	0.138	0.154

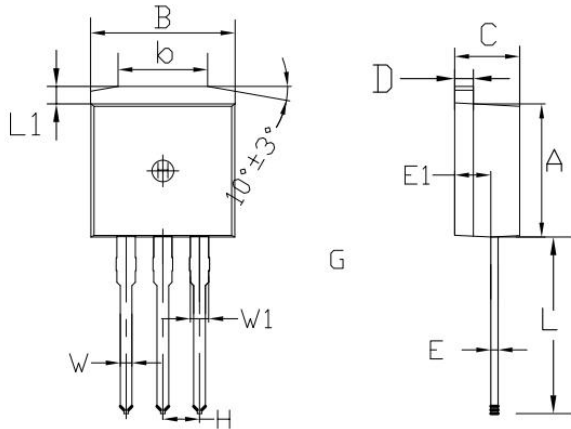
TO-220F PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	min.	max.	min.	max.
A	8.80	9.30	0.346	0.366
B	10.00	10.50	0.394	0.413
C	4.30	4.90	0.169	0.193
D	2.30	2.70	0.091	0.106
L	15.55	16.15	0.612	0.636
h	0.40	0.60	0.016	0.024
L1	3.15	3.55	0.124	0.140
L2	12.65	13.35	0.498	0.526
W	0.70	0.90	0.028	0.035
W1	1.15	1.55	0.045	0.061
H	2.54 TYP		0.100 TYP	
E	0.48	0.53	0.019	0.021
phi	2.90	3.40	0.114	0.134
E1	2.40	2.90	0.094	0.114
F	7.75	8.25	0.305	0.325
F1	7.35	7.85	0.289	0.309

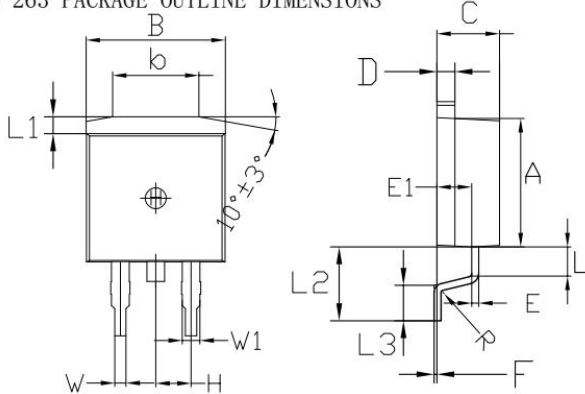
9 Dimensions(continues)

TO-262 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	min.	max.	min.	max.
A	8.80	9.30	0.346	0.366
B	9.70	10.30	0.382	0.406
C	4.25	4.75	0.167	0.187
D	1.20	1.45	0.047	0.057
E	0.40	0.60	0.016	0.024
L	12.25	13.75	0.482	0.541
L1	1.15	1.45	0.045	0.057
E1	2.4	2.6	0.0945	0.1024
W	0.80	0.82	0.0315	0.034
W1	1.20	1.30	0.047	0.051
H	2.54 TYP		0.200 TYP	
b	5.50	6.50	0.216	0.256

TO-263 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	min.	max.	min.	max.
A	8.80	9.30	0.346	0.366
B	9.70	10.30	0.382	0.406
C	4.25	4.75	0.167	0.187
D	1.20	1.45	0.047	0.057
E	0.40	0.60	0.016	0.024
L	1.90	2.30	0.075	0.091
L1	1.15	1.45	0.045	0.057
R	0.24	0.26	0.0095	0.0102
W	0.80	0.82	0.0315	0.0323
W1	1.20	1.30	0.047	0.051
H	2.54 TYP		0.200 TYP	
b	5.50	6.50	0.216	0.256
E1	2.4	2.6	0.0946	0.1024
L2	5.20	5.80	0.205	0.228
L3	2.20	3.20	0.087	0.126
F	0.03	0.23	0.0012	0.0091

10 Attentions

- ROUM Semiconductor Technology CO.,LTD. reserves the right to change the specification without prior notice! The customer should obtain the latest version of the information before making the order and verify that the information is complete and up to date.
- It is the responsibility of the purchaser for any failure or failure of any semiconductor product under certain conditions. It is the responsibility of the purchaser to comply with safety standards and to take safety measures in the system design and machine manufacturing of Roma products in order to avoid potential risk of failure. Injury or property damage.
- Product promotion is endless, our company will be dedicated to provide customers with better products.

11 Appendix

Revision history:

Date	REV.	Description	Page
2017.03.14	1.0	Original	